

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: To Be Assigned
Applicant: Shigeru Morimoto et al.
Filed: September 30, 2003
Title: A PRINTED CIRCUIT BOARD, A BUILDUP SUBSTRATE, A
METHOD OF MANUFACTURING PRINTED CIRCUIT BOARD,
AND AN ELECTRONIC DEVICE (AS AMENDED)

TC/A.U.: To Be Assigned
Examiner: To Be Assigned
Confirmation No.: To Be Assigned
Docket No.: MTS-3463US

PRELIMINARY AMENDMENT***Mail Stop Patent Application***

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Prior to examination, please amend the above-identified application as follows:

- ☒ **Amendments to the Title** begin on page **2** of this paper.
- ☒ **Amendments to the Specification** begin on page **3** of this paper.
- ☒ **Amendments to the Claims** are reflected in the listing of claims which begins on page **9** of this paper.
- ☐ **Amendments to the Drawings** begin on page of this paper and include an attached replacement sheet(s).
- ☒ **Amendments to the Abstract** are on page **14** of this paper. A clean version of the Abstract is on page **15** of this paper.
- ☐ **Remarks/Arguments** begin on page of this paper.

Amendments to the Title:

Please replace the Title with the following:

A PRINTED CIRCUIT BOARD, A BUILDUP SUBSTRATE, A METHOD OF
MANUFACTURING PRINTED CIRCUIT BOARD, AND AN ELECTRONIC DEVICE